



Oregon
Chip Seal
Design and Specifications

Ashley Buss
Minas Guirguis
Doug Gransberg

Project

Acknowledgements

- **Oregon Department of Transportation**
- **Jon Lazarus and Larry Ilg.**
- **Binder suppliers for these projects**
- **Chip seal contractors for their help on the construction site.**
- **R. Christopher Williams, Paul Ledtje, Ben Claypool, Marie Grace Mercado, Jinhua Yu, and Jesse Studer at Iowa State University**

Project Introduction

- **Objectives**
 - Document methods of chip sealing
 - Report the performance of chip seals
 - Apply Chip Seal Design
 - Identify best practices for implementation

Project Introduction

- **Benefits**

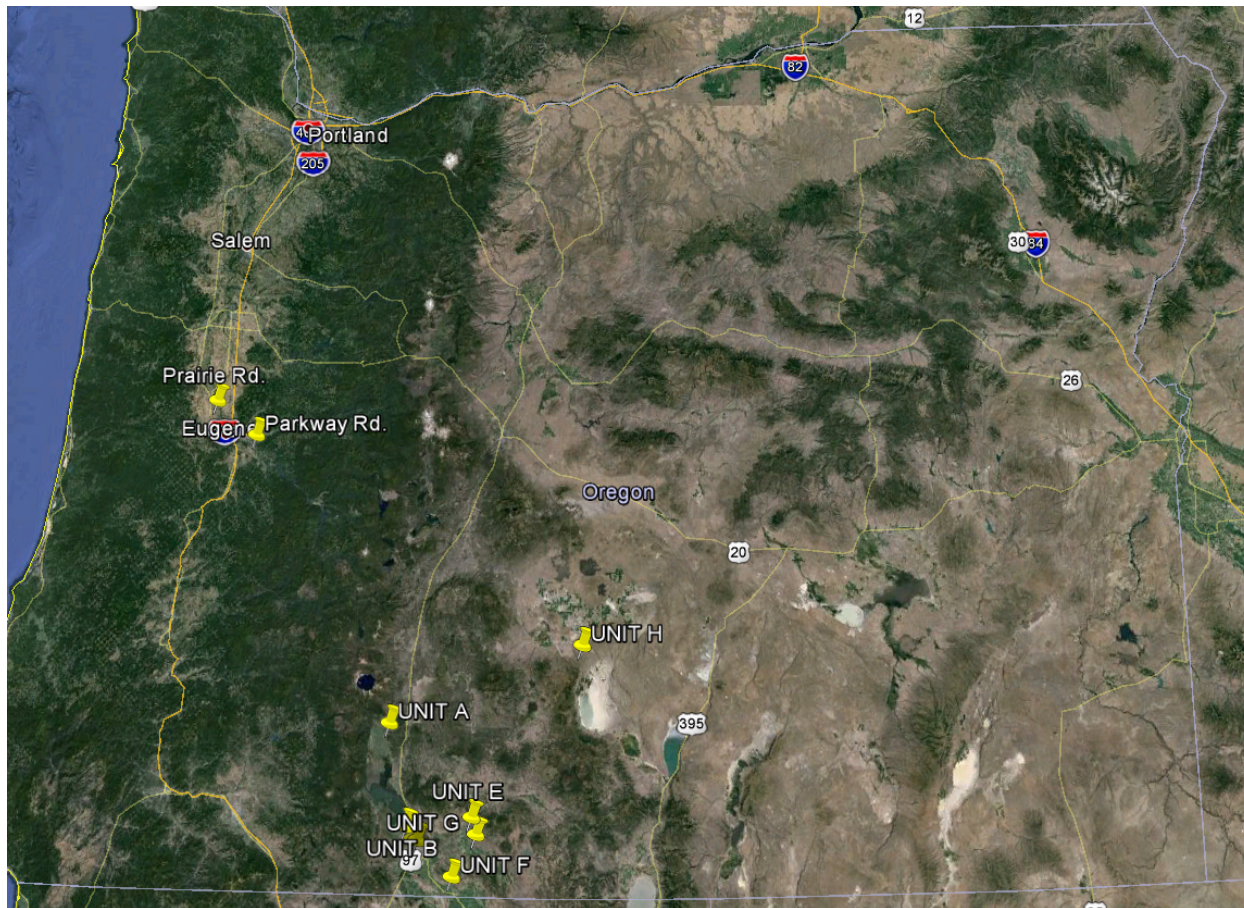
- **Improve the cost effectiveness of chip seals by increasing performance**
- **Improved roadway surfaces**
- **Integrate a rational method for binder and aggregate application rates**

Project Introduction

- **Literature Review and Best Practices**
 - **Design Methods**
 - **NCHRP Synthesis 342**
 - **Performance Specifications**
 - **Specification Review and Comparison**
- **Experimental Plan**
 - **Hot Applied and Emulsified Chip Seal**
 - **Various Regions in Oregon**
 - **Variety of ADT**

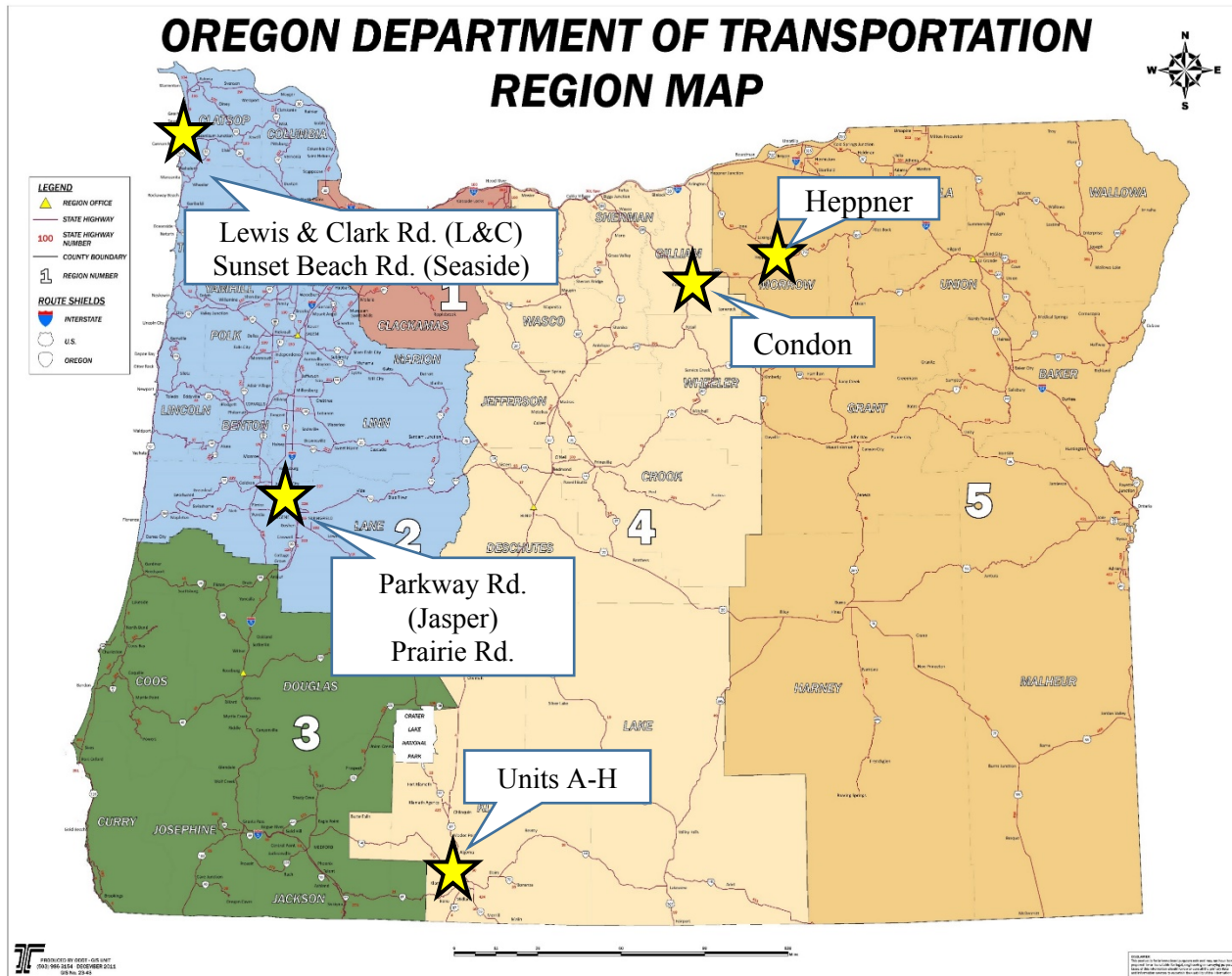
Chip Seal Locations

- **Map of 2014 Chip Seal Projects**



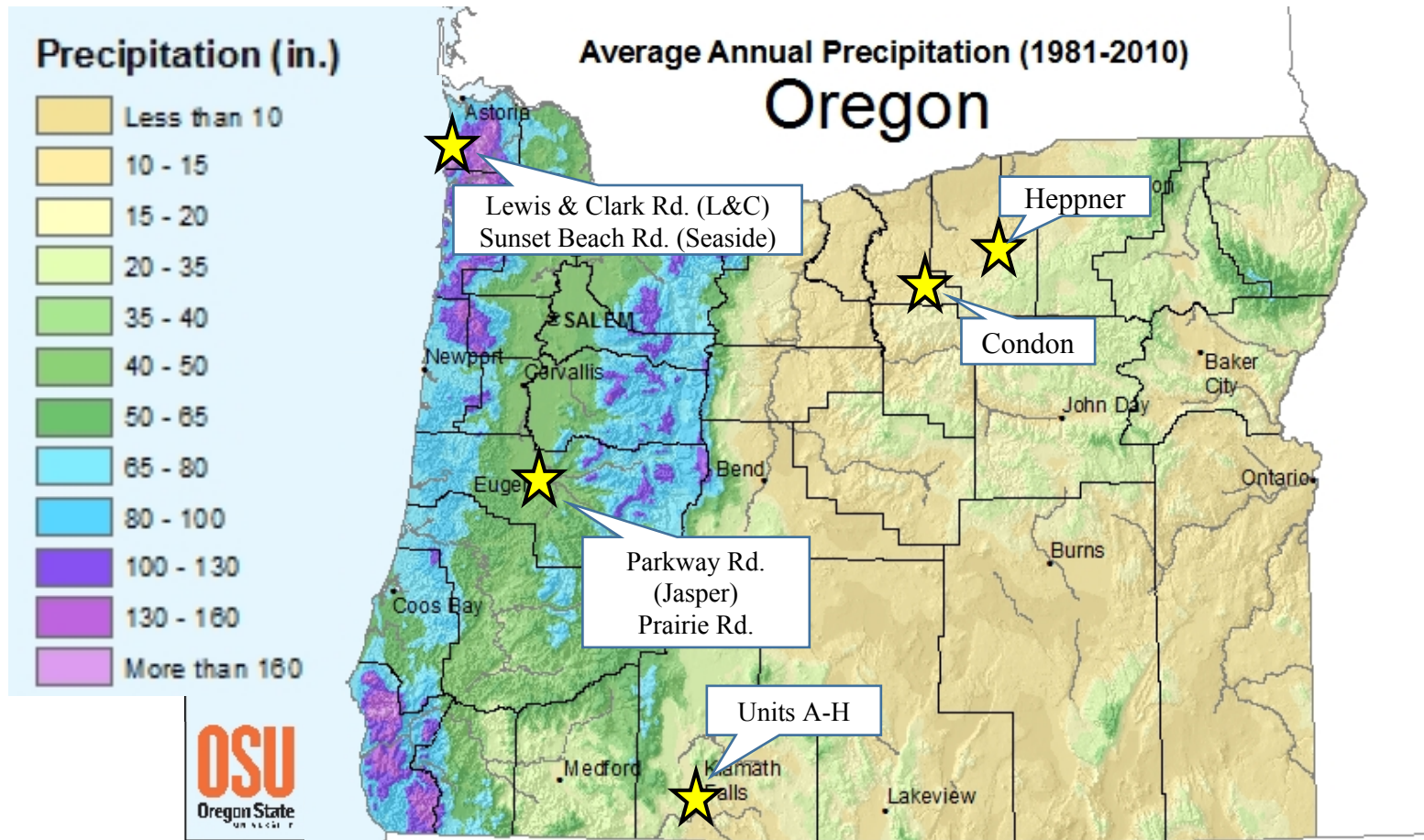
Chip Seal Locations

- Map of All Project Locations



Chip Seal Locations

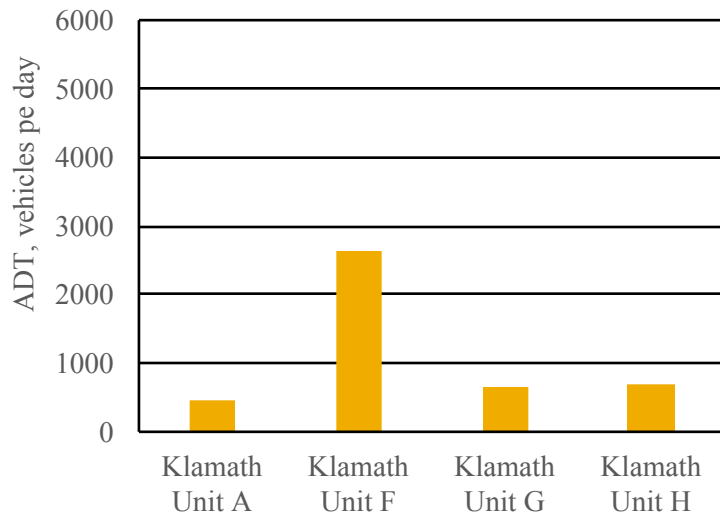
Map of All Project Locations and Rainfall



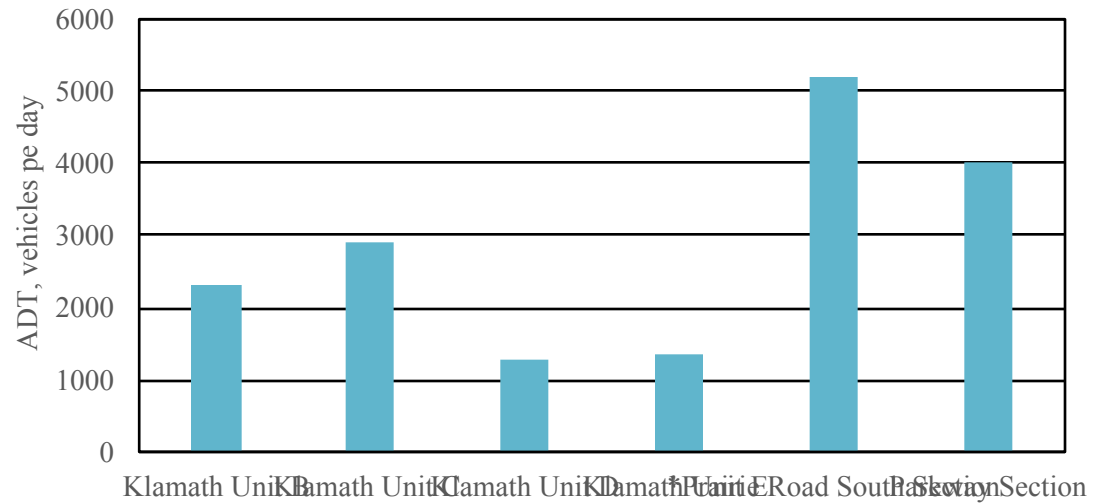
Types of Chip Seals

■ ADT for 2014 Sections

Emulsion



Hot Apply

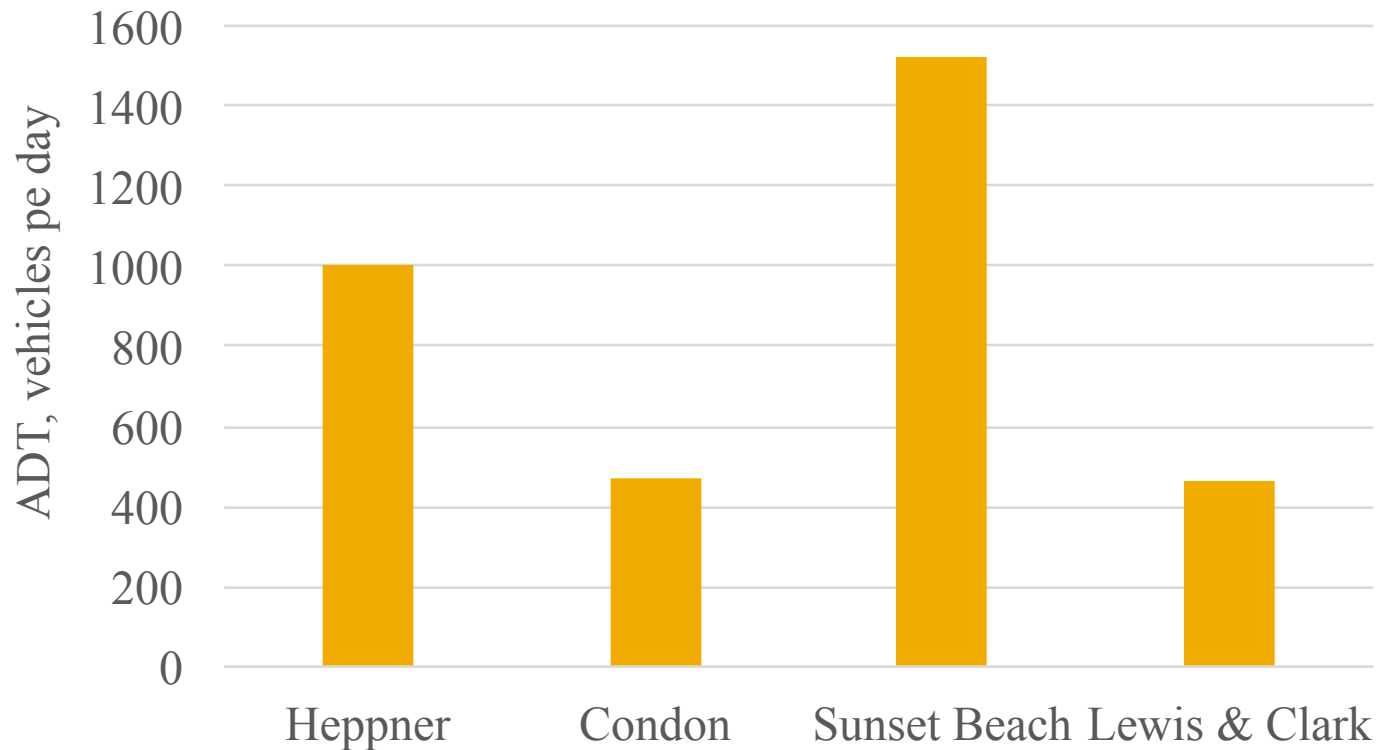


Klamath Falls

Eugene

Types of Chip Seals

- **ADT for 2015 Sections – Emulsion**



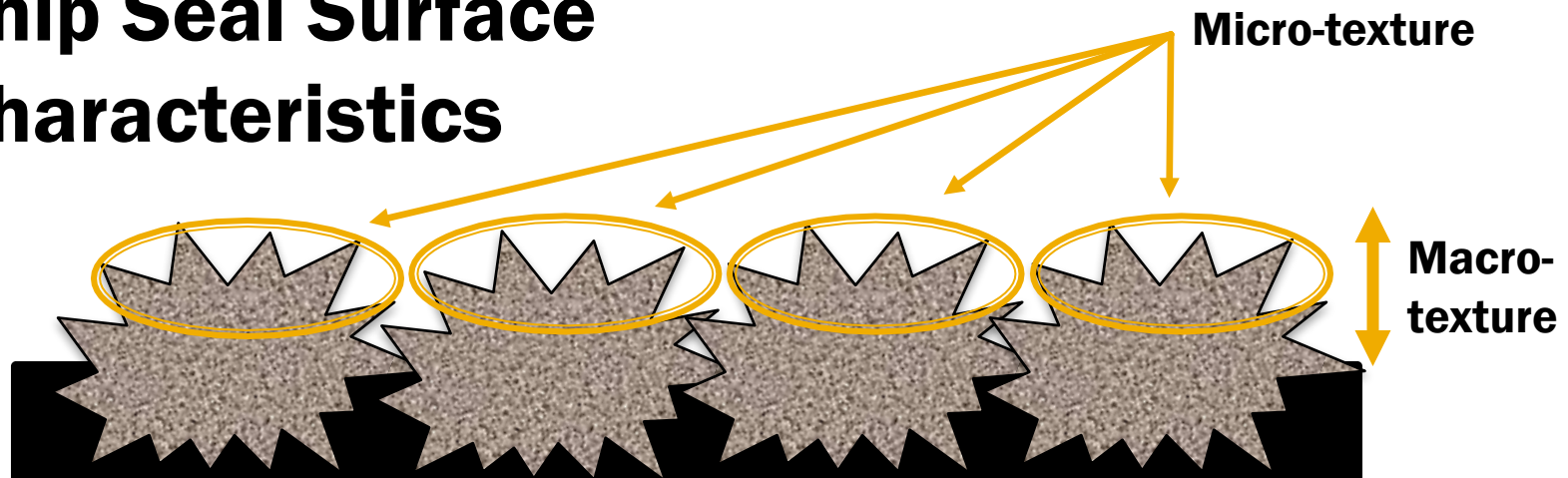
Types of Chip Seals

- **Single Layer Chip Seals Studied**
 - **Hot Applied**
 - **Emulsified Asphalt**
 - **All sections used polymer modified binders**



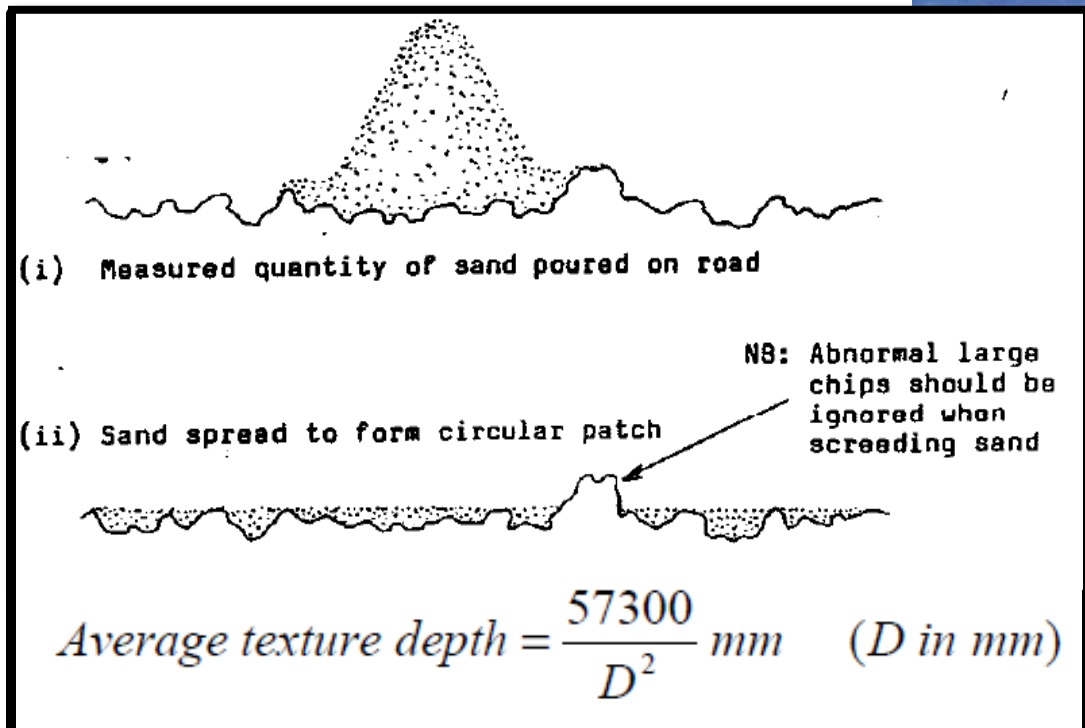
Chip Seal Performance

- **Characterization of Existing Pavement**
 - **Pavement Condition Surveys**
 - **Oregon DOT Pavement Management System Rating**
- **Chip Seal Surface Characteristics**



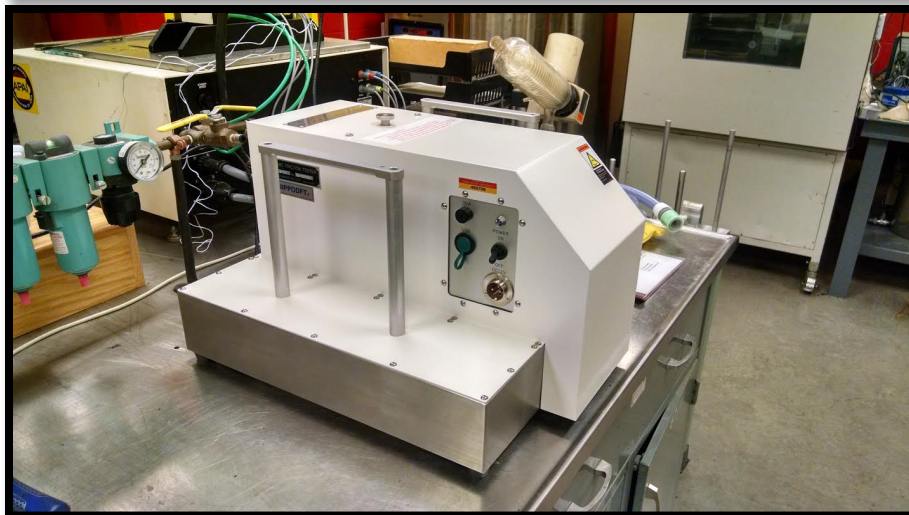
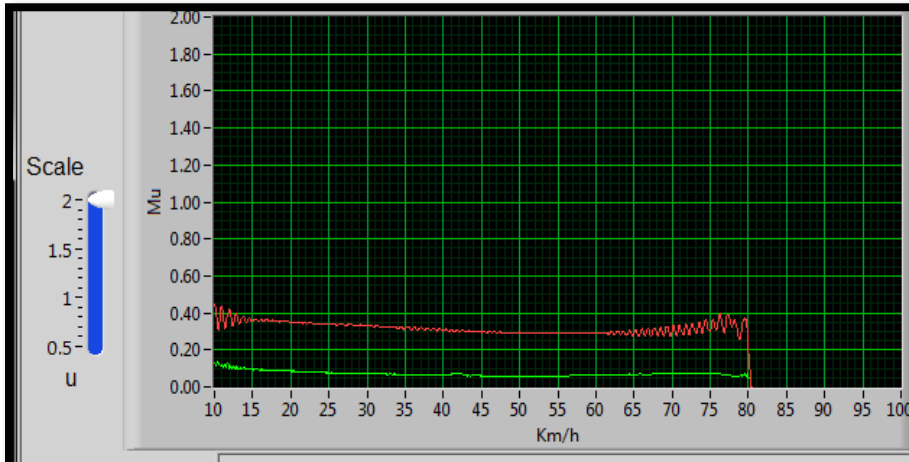
Chip Seal Performance

■ Macro-texture – Sand Circles



Chip Seal Performance

- **Micro-texture – Dynamic Friction Tester**



Chip Seal Specifications

- Can a Macrotexture performance specification be applied in Oregon?
- New Zealand Performance Specification

New Zealand Transport Agency – P/17 Performance Specification for chip seal macrotexture deterioration

$$Td_1 = 0.07 ALD \log Y_d + 0.9$$

Where:

Td_1 = texture depth in one year (mm)

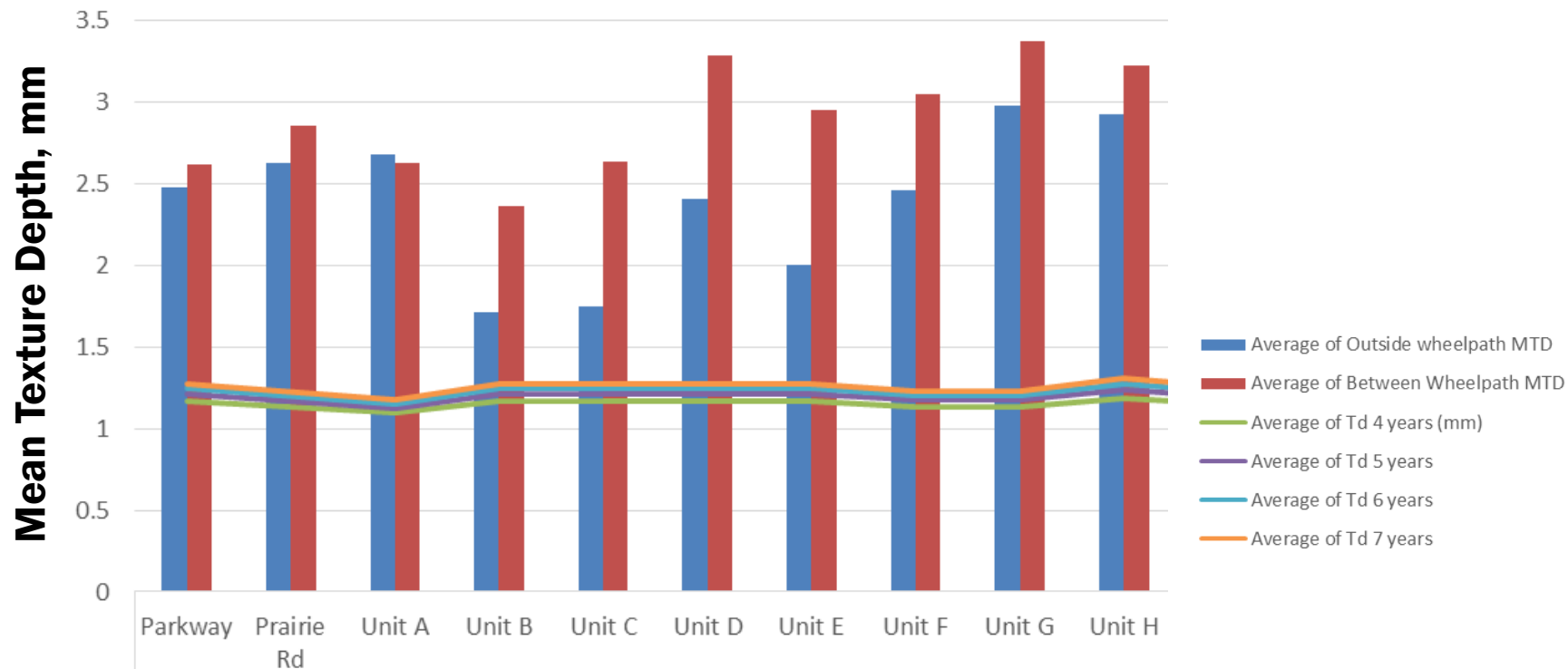
Y_d = design life in years

ALD = average least dimension of the aggregate (mm)

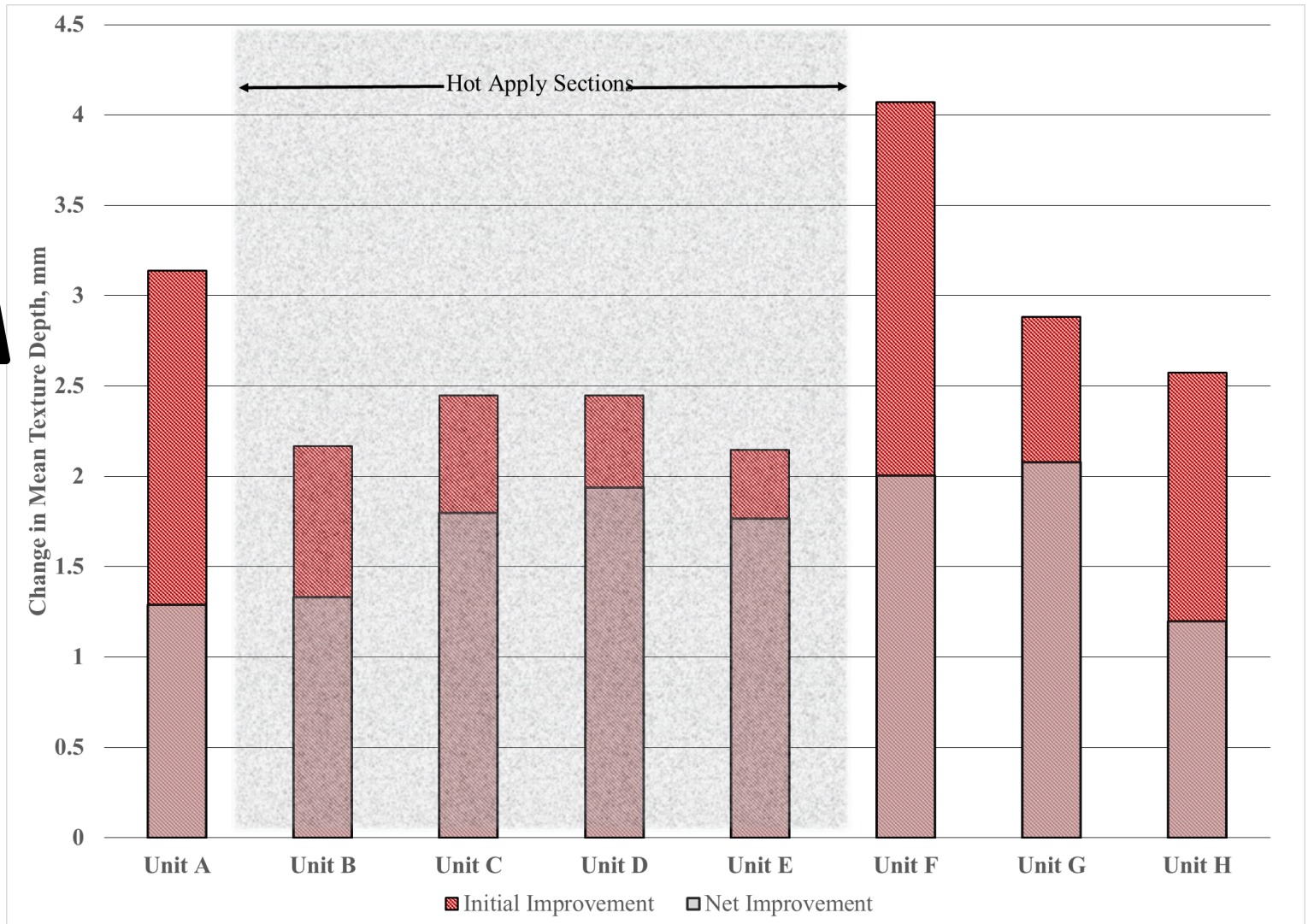
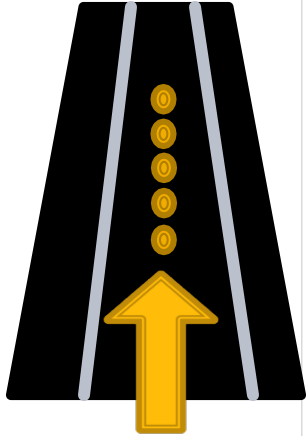
0.9 mm is considered failure

Chip Seal Specification

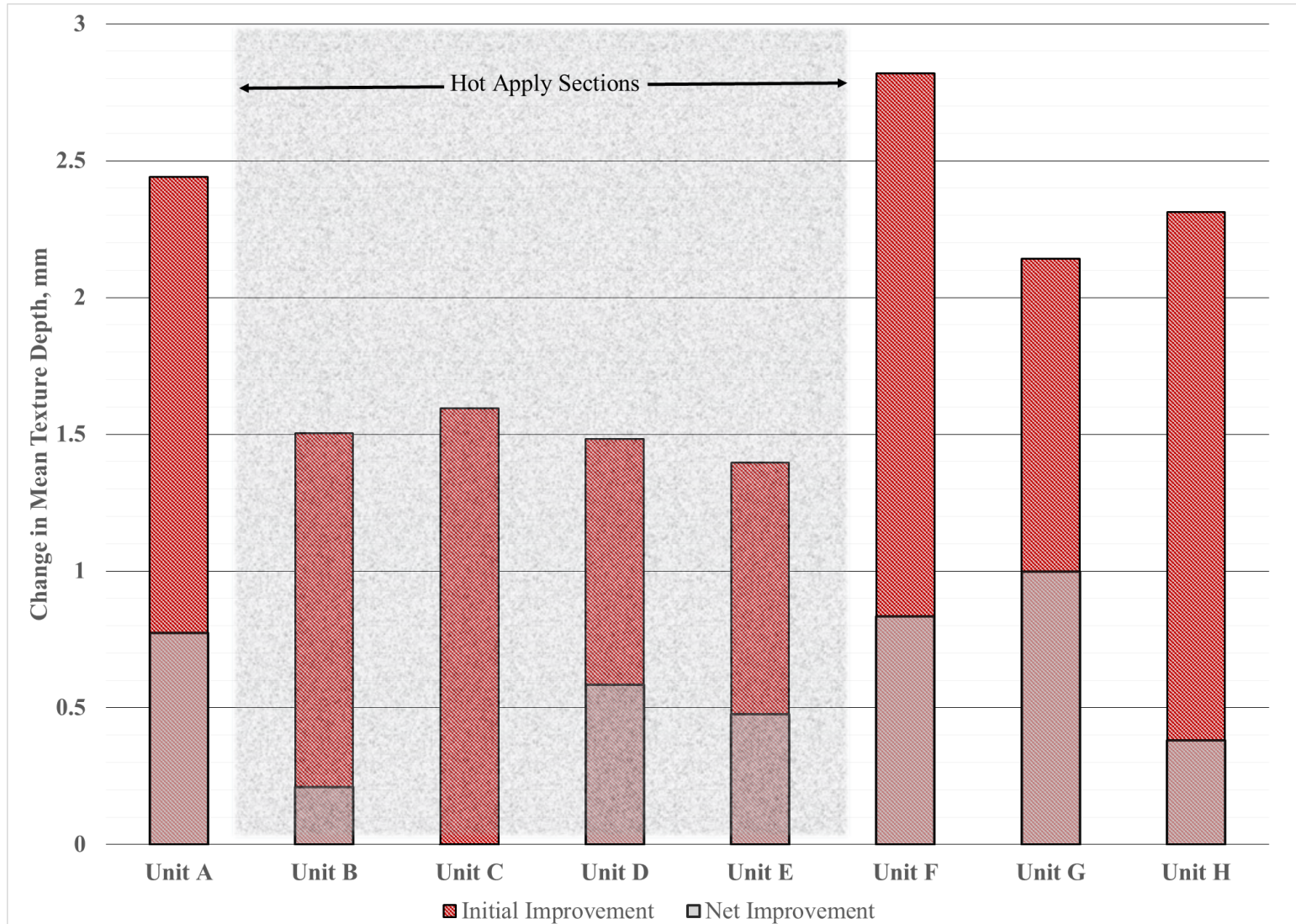
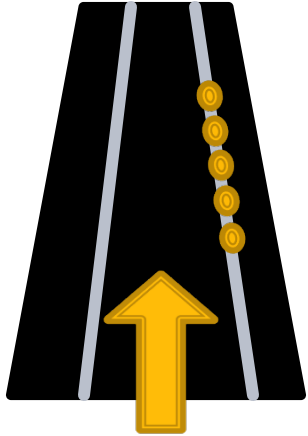
- **New Zealand Performance Specification**
 - **Blue is the performance specification**
 - **Red is shown for illustration**



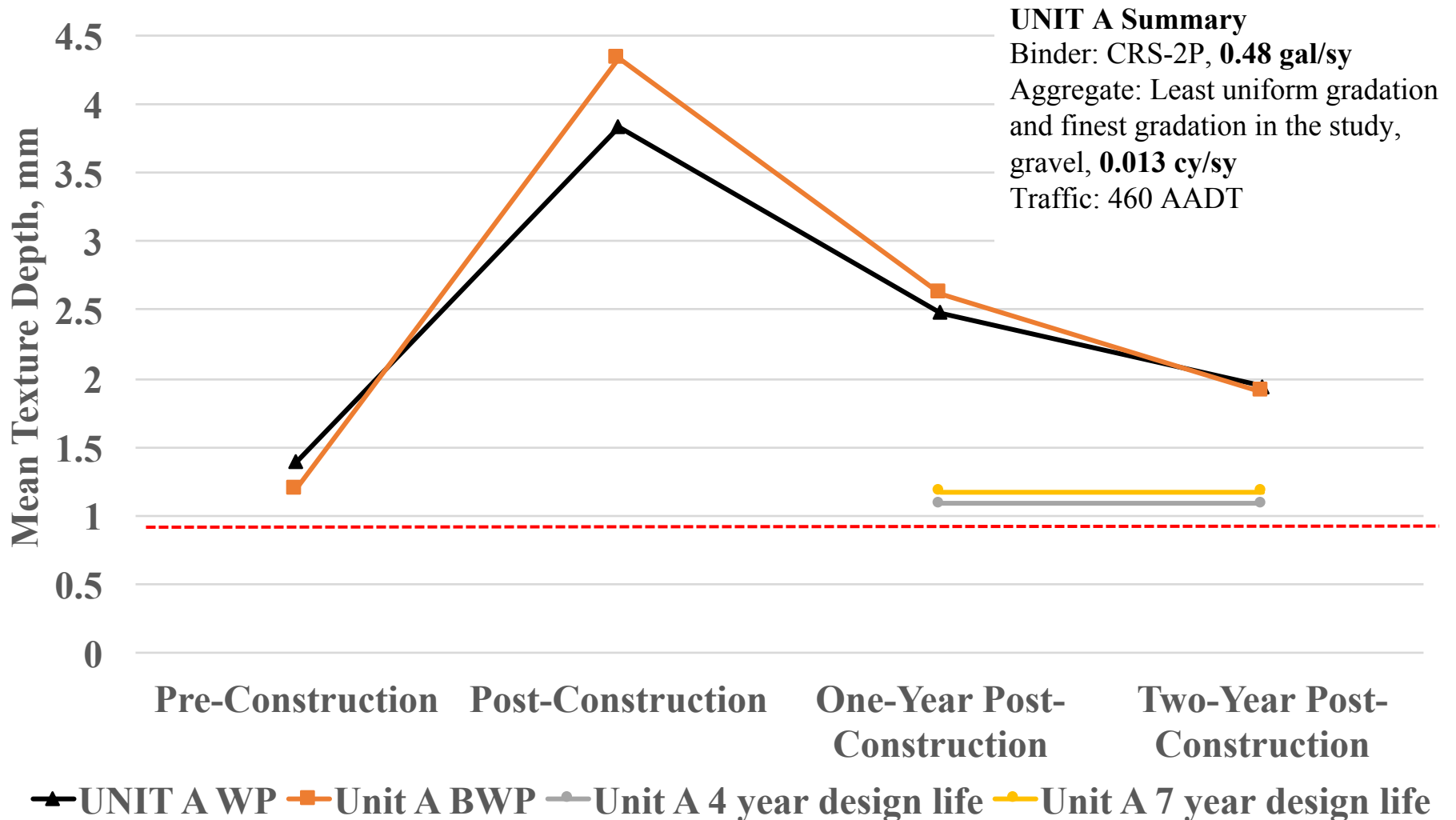
Macrotexture Changes over Time - Between WP



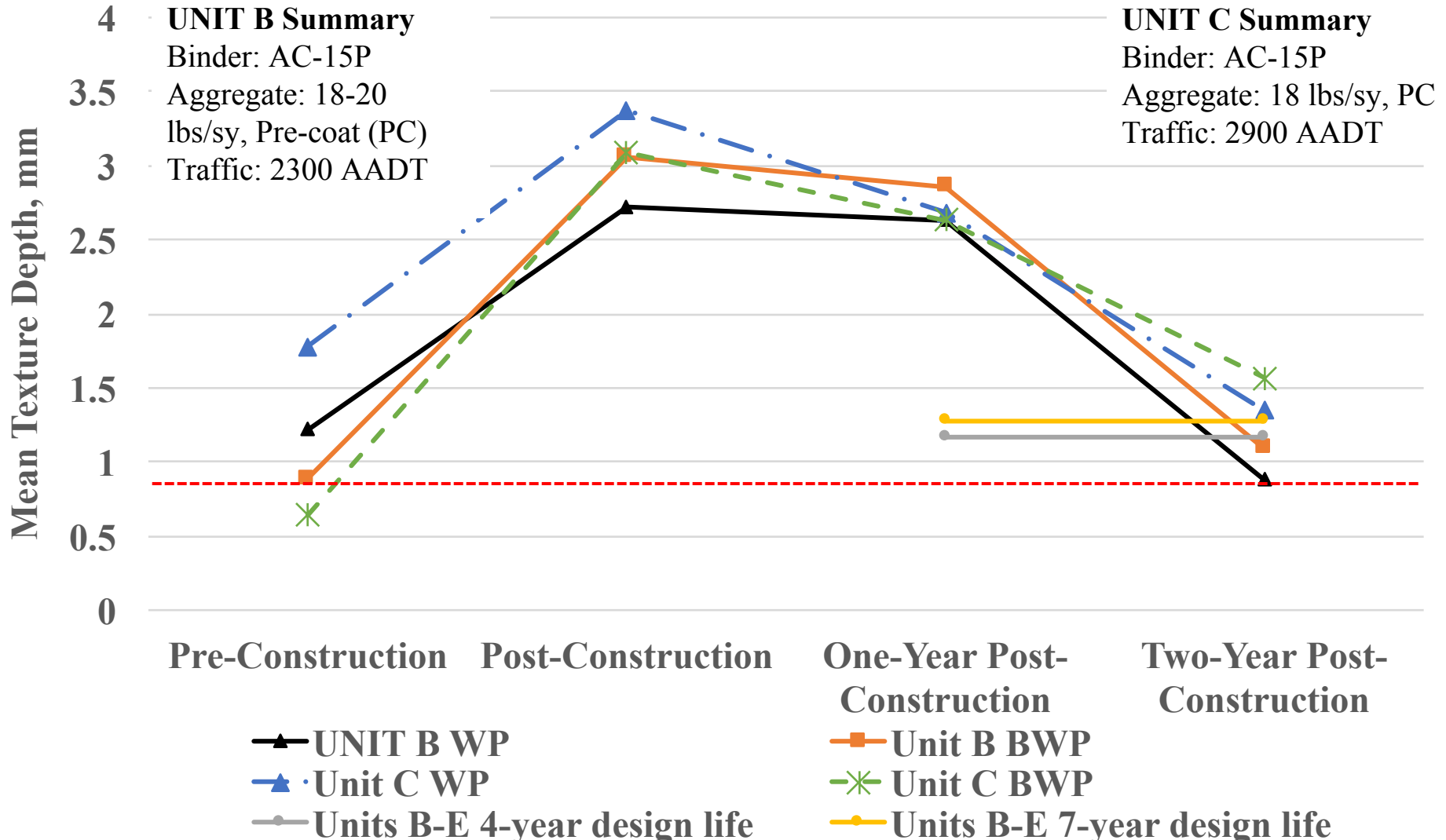
Macrotexture Changes over Time - In the WP



Macrotexture Changes over Time - Unit A

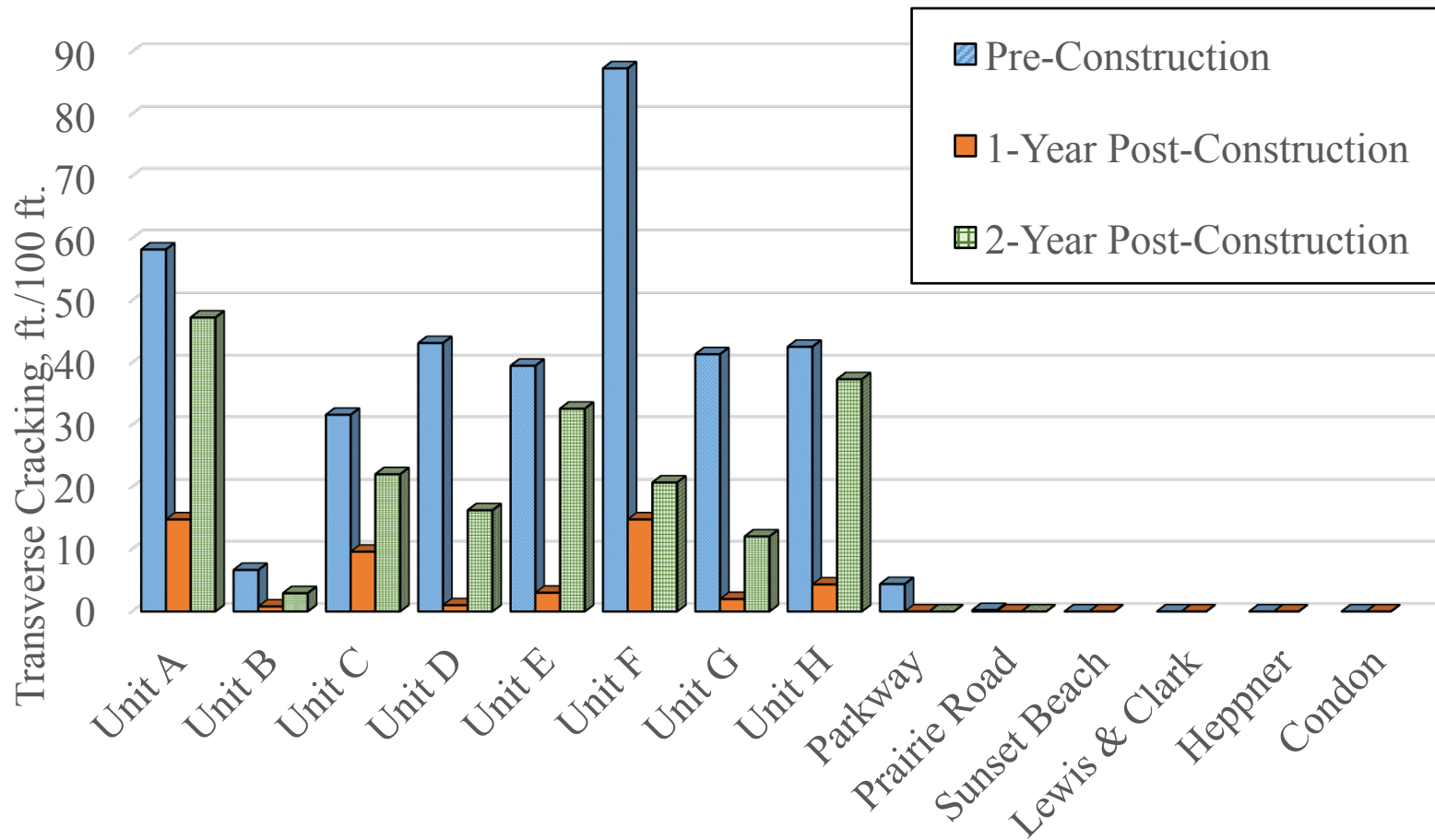


Macrotexture Changes over Time - Units B and C



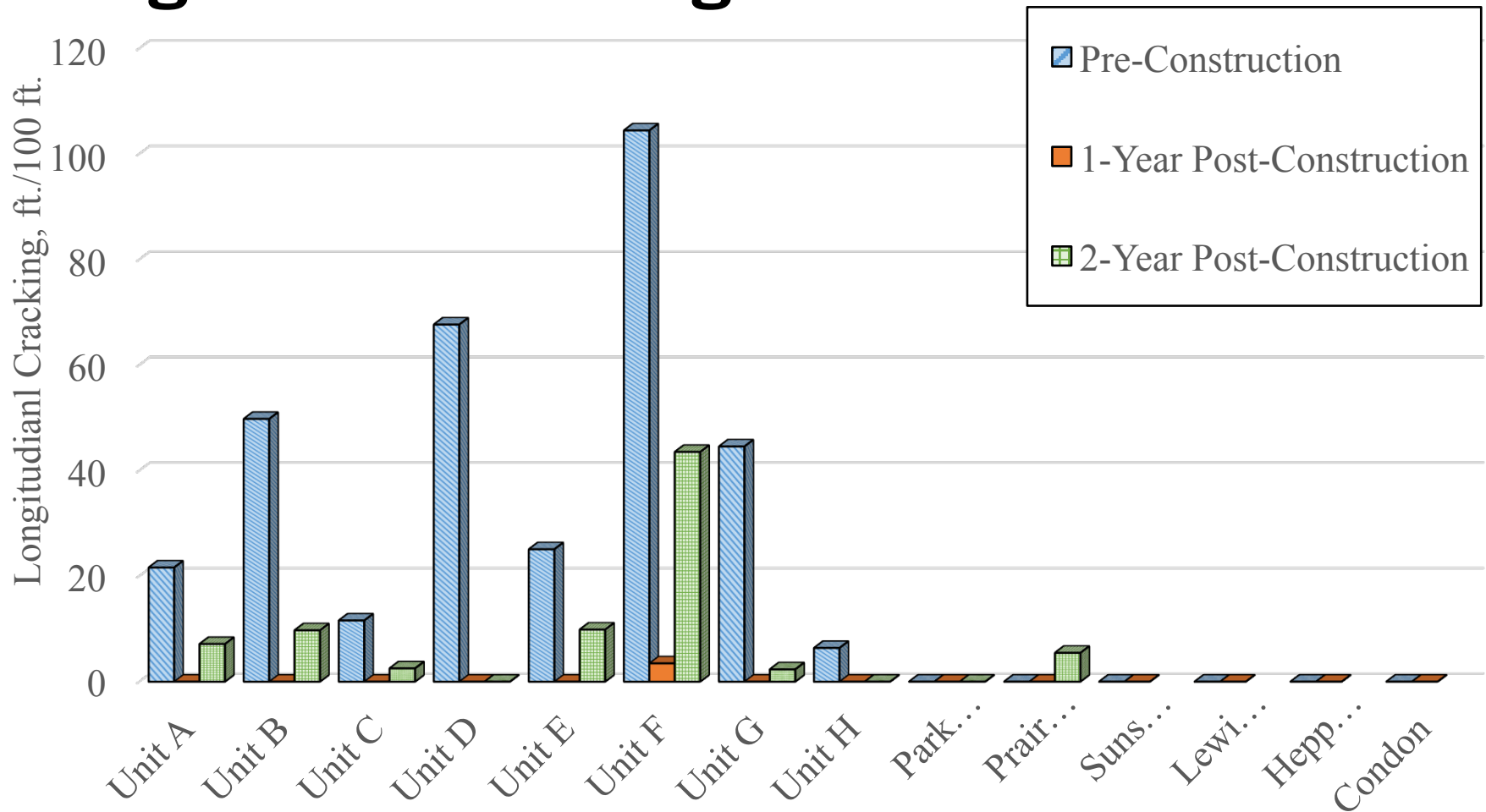
Performance Surveys

■ Transverse Cracking



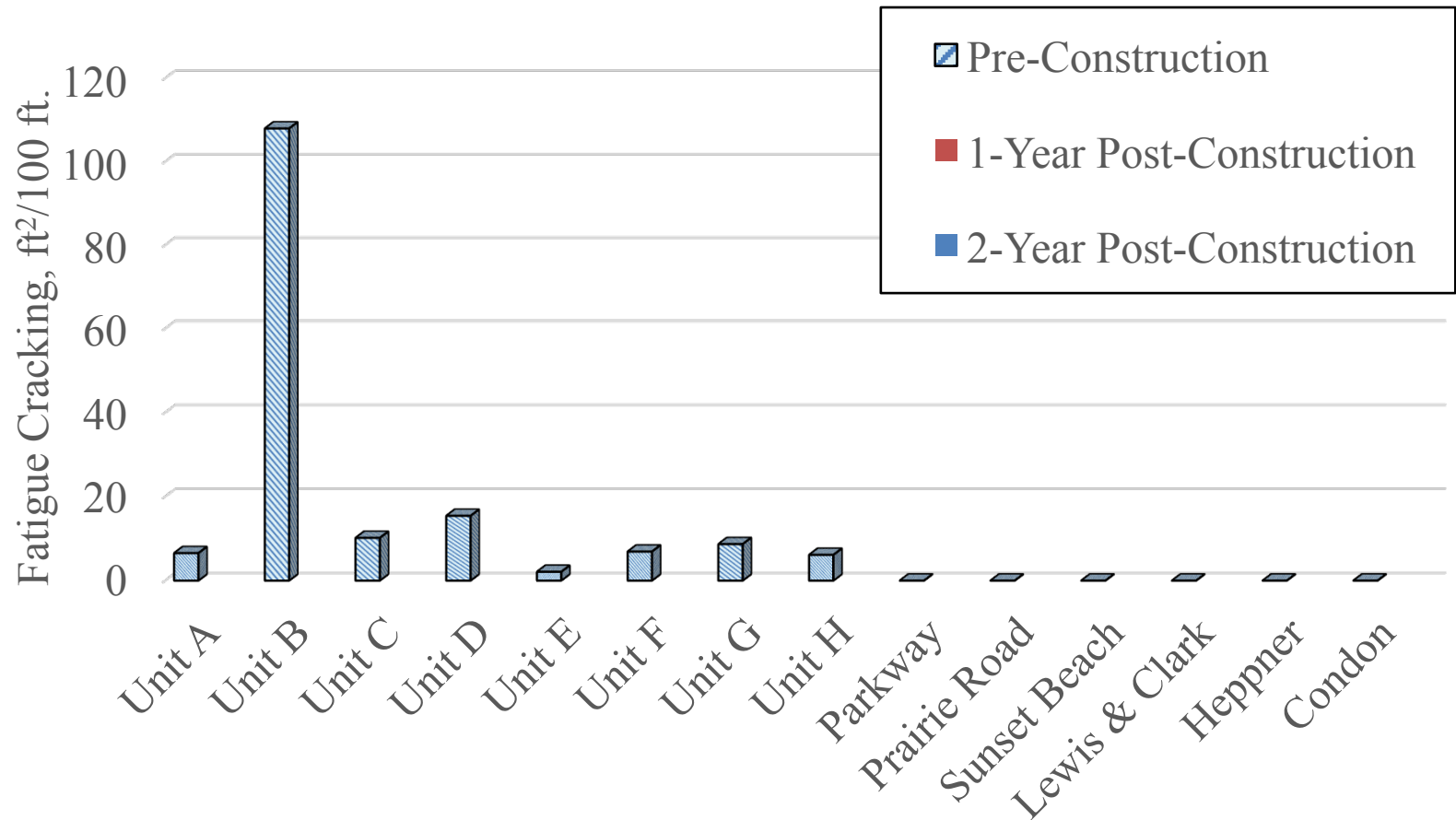
Performance Surveys

■ Longitudinal Cracking



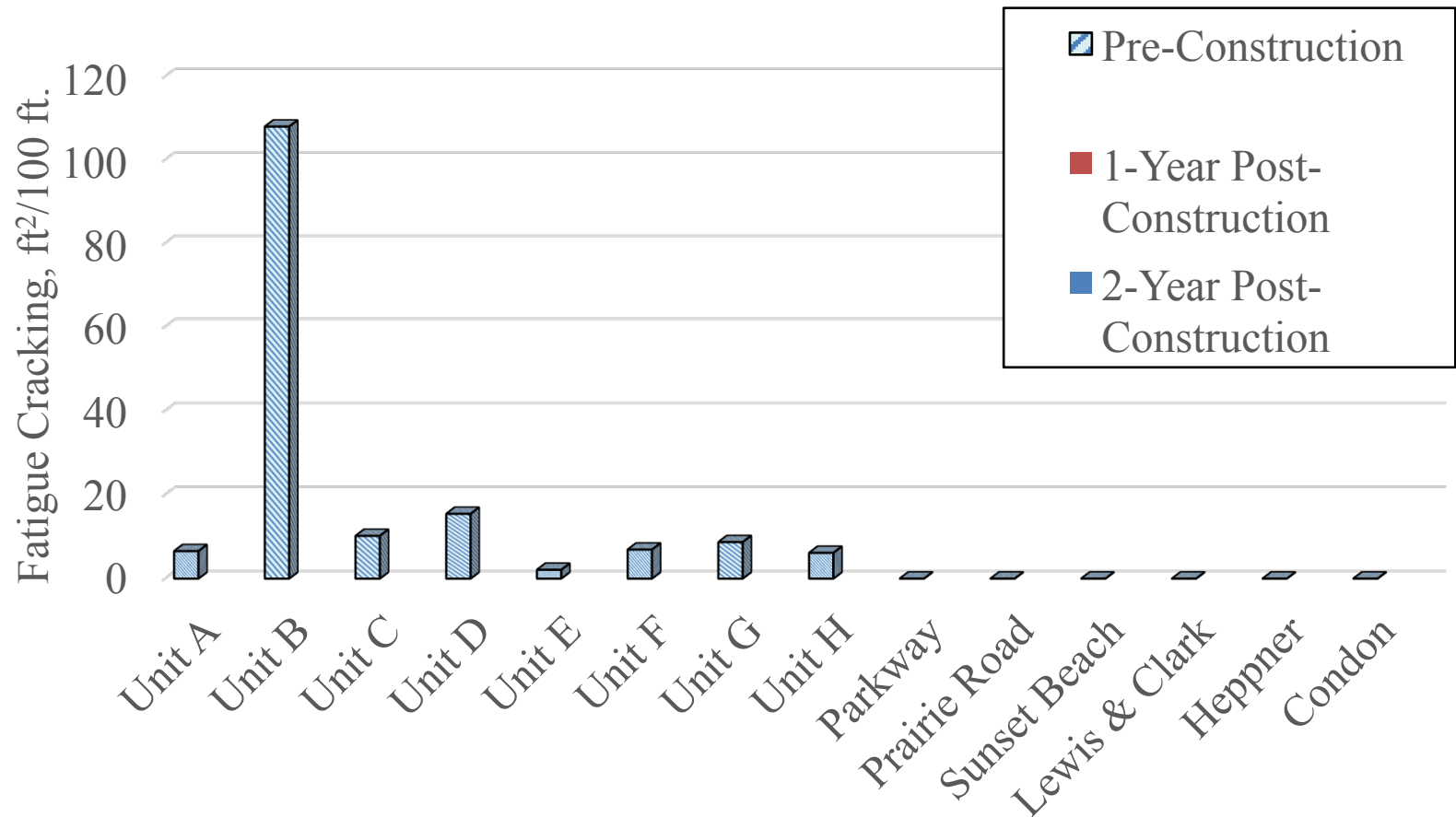
Performance Surveys

■ Fatigue Cracking



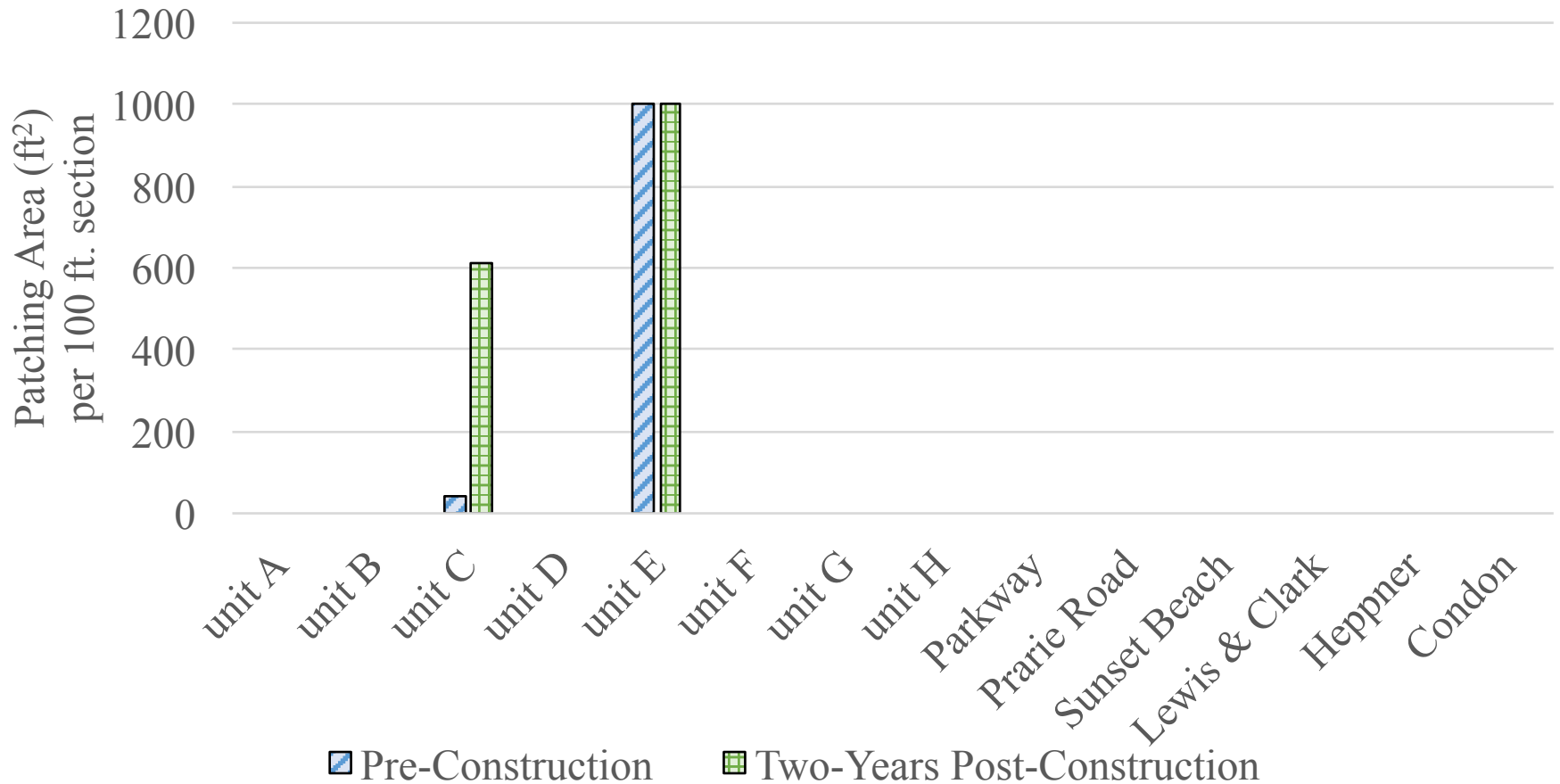
Performance Surveys

■ Fatigue Cracking



Performance Surveys

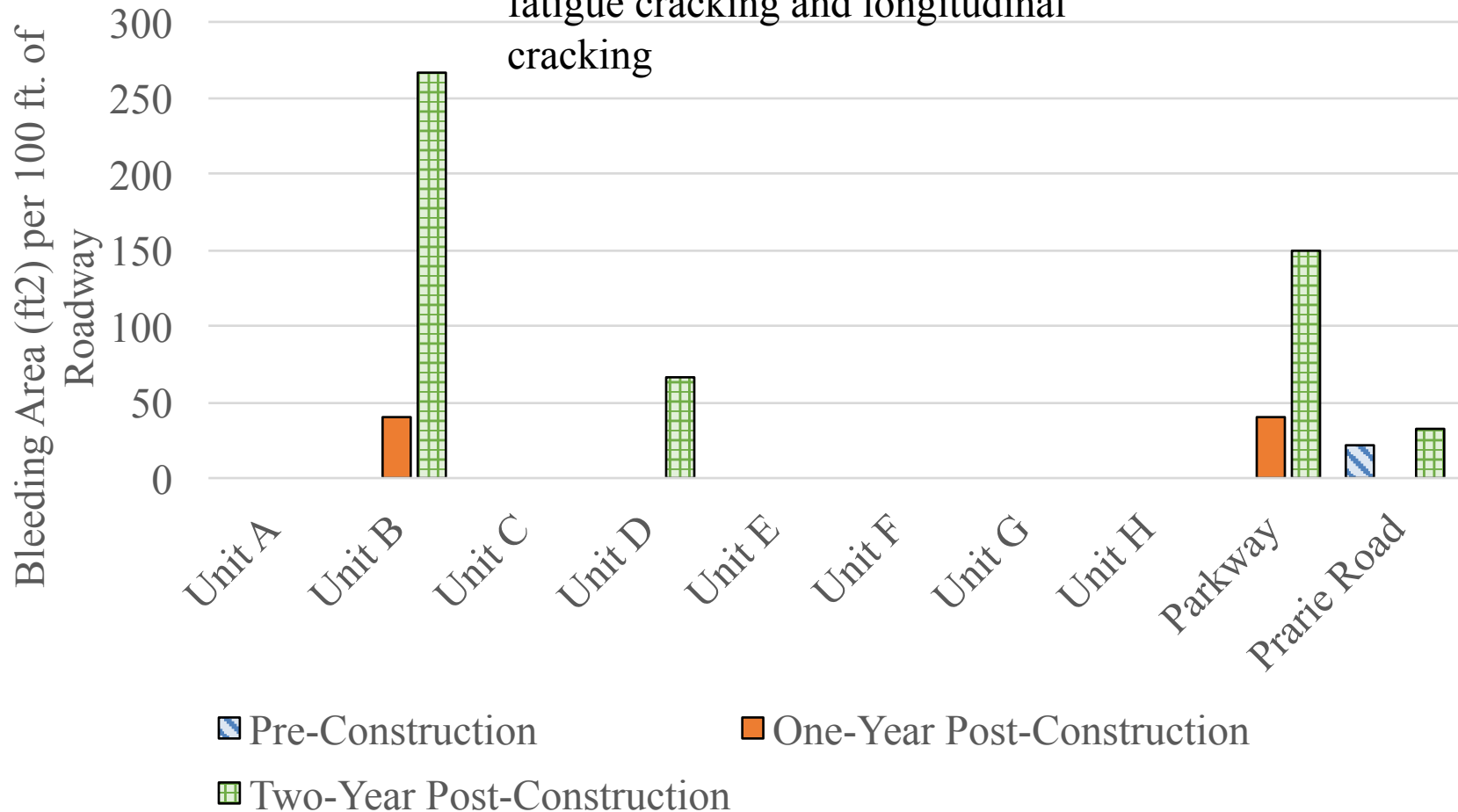
■ Patching Area



Performance Surveys

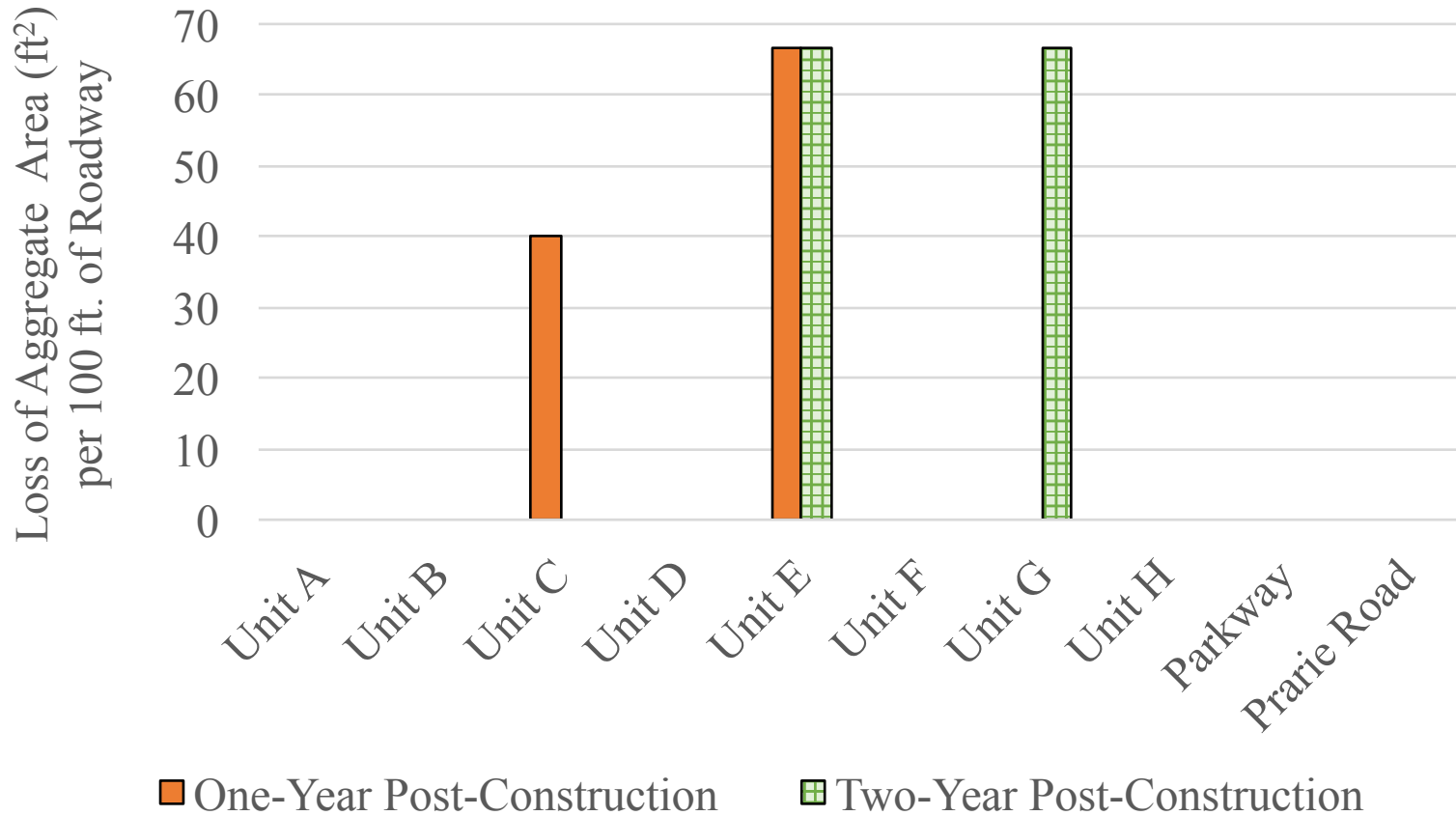
■ Bleeding

Unit B had highest pre-construction fatigue cracking and longitudinal cracking



Performance Surveys

■ Chip Seal - Loss of Aggregate

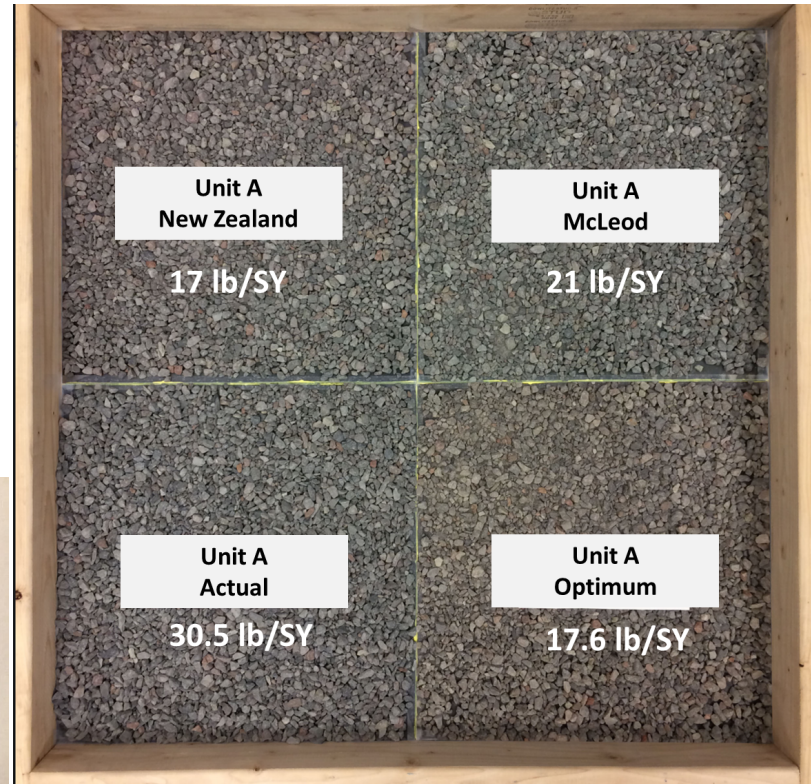


Chip Seal Design

- **Back calculate the chip seal design using:**
 - **McLeod Method (MnDOT Seal Coat Design Manual)**
 - **New Zealand Design Method**
 - **Optimal one-stone thick**
- **Compare with actual applied rates**

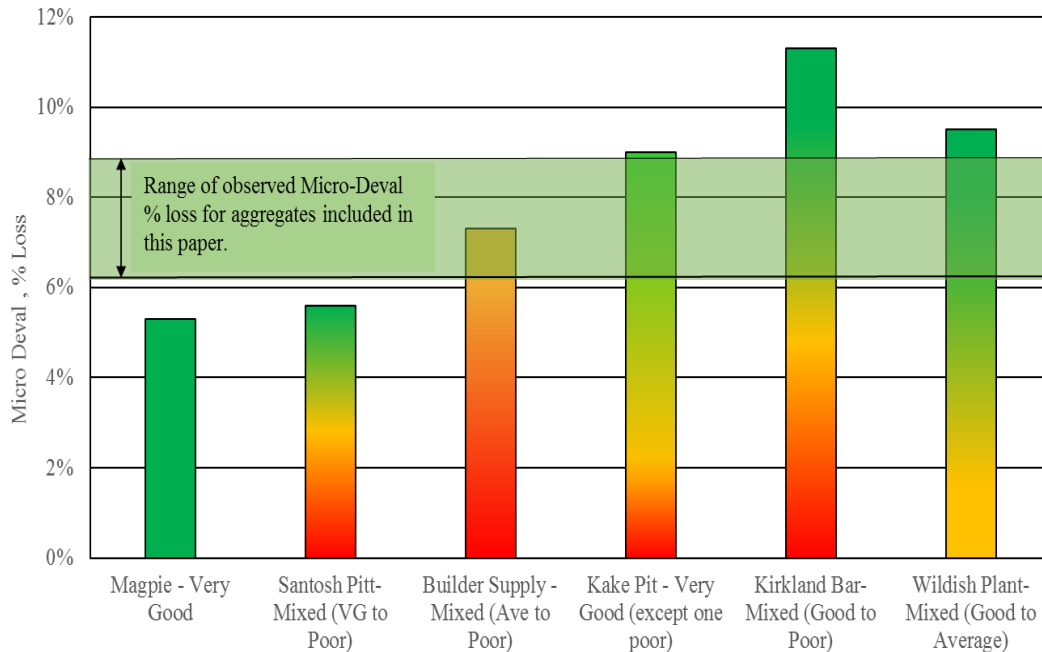
Laboratory Investigation

■ Aggregate Properties



Micro-Deval Testing

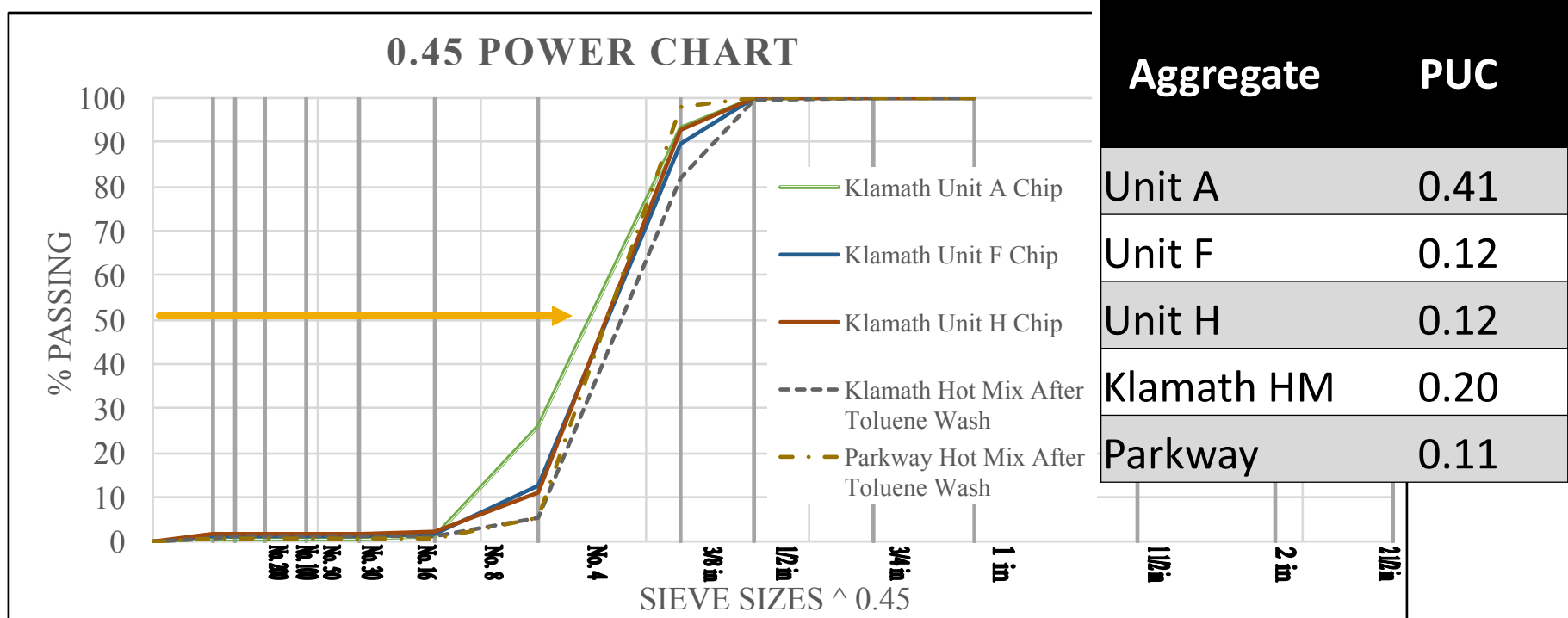
- **Micro-Deval Testing**
 - **Similar Values for all aggregates tested**
 - **Compared with previous Oregon Aggregate Study**



Sample ID	Percent Loss
Unit A Klamath Chips	6.09
Unit F Klamath Chips	7.45
Unit H Klamath Chips	8.60
Hot Applied Klamath Chips	7.21
Parkway Eugene Chips	6.76

Aggregate Gradation and PUC

- Performance Uniformity Coefficient
 - Indicates Aggregate Size Uniformity
 - Lower PUC = More Uniform Gradation



Aggregate Gradation and PUC

Aggregate	Aggregate contributing to bleeding (P_{EM}), %	Aggregate contributing to loss ($100-P_{2EM}$), %	PUC
Unit A	33	20	0.41
Unit F and G	11	10	0.12
Unit H	11	6	0.12
Klamath Hot Applied Sections (Units B-E)	16	18	0.20
Parkway	11	2	0.11

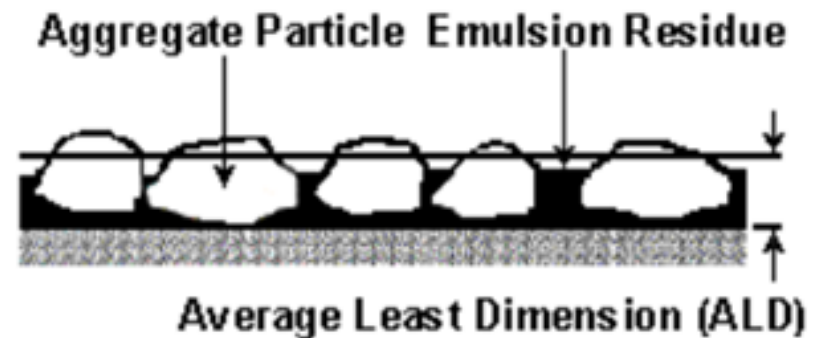
McLeod: Flakiness Index

Test Section	Flakiness Index	AADT
Parkway	5.2	4000
Unit A	13.1	460
Unit B	5.2	2300
Unit C	5.2	2900
Unit D	5.2	1280
Unit E	5.2	1345
Unit F	6.4	2650
Unit G	6.4	670
Unit H	12.1	690



McLeod and New Zealand Average Least Dimension

- New Zealand and Austroads measure each aggregate particle
- Flakiness index provides relationship
- The average least dimension is determined by:
 - $H = [M / 1.139285 + (0.011506) * FI]$
 - H = Average Least Dimension (ALD)
 - M = Median Particle Size
 - FI = Flakiness Index



(California Division of Maintenance 2003; FHWA 1992)

Loose Unit Weight

- A metal cylinder with a known volume of is loosely filled with aggregate until full. The weight of the aggregate was determined.
- Find Voids in Loose Aggregate



Test Section	LUW
Parkway	89.3
Unit A	86.9
Unit B	85.4
Unit C	85.4
Unit D	85.4
Unit E	85.4
Unit F	87.7
Unit G	87.7
Unit H	82.6

McLeod Traffic Considerations

- **Traffic Volume**
 - **Factor accounts for the role that traffic volumes play in achieving the ultimate embedment of 80 percent (20 percent void space).**

Test Section	AADT	McLeod Traffic Correction Factor	Traffic whip-off factor, E
Parkway	4000	0.60	1.1
Unit A	460	0.75	1.05
Unit B	2300	0.60	1.1
Unit C	2900	0.60	1.1
Unit D	1280	0.65	1.1
Unit E	1345	0.65	1.1
Unit F	2650	0.60	1.1
Unit G	670	0.70	1.1
Unit H	690	0.70	1.1

VEHICLES/DAY	0-100	101-500	501-1000	1001-2000	>2000
Correction Factor	0.85	0.75	0.70	0.65	0.60

(Wood et al. 2006)

Traffic Considerations

- **Traffic Whip-Off (Similar to NZ)**
 - **Assume 5% for low volume, residential type traffic**
 - **Assume 10% for higher speed roads such as county roads.**

McLeod Aggregate Design Equation

- Aggregate Application Rate:

- $C = (1 - 0.4V) \times H \times G \times E$

- C = Cover Aggregate (kg/m²)**
 - V = Voids in Loose Agg. (%)**
 - H = ALD (mm)**
 - G = Bulk Specific Gravity**
 - E = Wastage Factor (%)**

Test Section	McLeod Cover Aggregate Rate (lbs/yd ²)	Actual Rate (lbs/yd ²)	Rates given in CY/SY
Parkway	26	20	
Unit A	21	30.5**	0.013
Unit B	27	19	
Unit C	27	18	
Unit D	27	20	
Unit E	27	19	
Unit F	25	30.8**	0.013
Unit G	25	30.8**	0.013
Unit H	23	23	

- **Values based on LUW

New Zealand Chip Seal Agg. Spread Rate

- For Single Coat Seals (Chipsealing in New Zealand)

- $Rate = \frac{750}{ALD} m^2/m^3$

Test Section	ALD (mm)	Rate m ² /m ³	Chip Rate lbs/SY
Parkway	5.9	127.5	21
Unit A	5.0	149.8	17
Unit B	6.3	119.4	21
Unit C	6.3	119.4	21
Unit D	6.3	119.4	21
Unit E	6.3	119.4	21
Unit F	5.8	128.5	20
Unit G	5.8	128.5	20
Unit H	5.5	136.5	18

Aggregate Absorption

- McLeod suggests an absorption correction factor, A , of 0.02 gal/yd² if the aggregate absorption is around 1%.
- MnDOT Seal Coat Handbook recommends if absorption is 1.5 percent or higher.

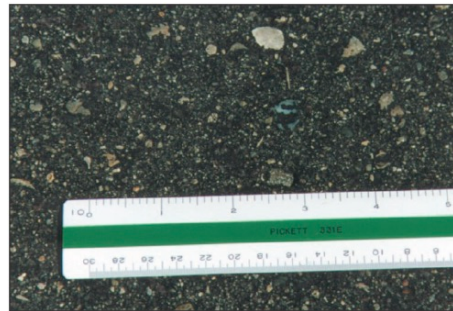
Test Section	Aggregate Absorption
Parkway	1.49
Unit A	2.01
Unit B	1.63
Unit C	1.63
Unit D	1.63
Unit E	1.63
Unit F	2.06
Unit G	2.06
Unit H	2.65

Aggregate type		Class A			Class B		Class C
		Granite	Quartzite	Trap Rock	Limestone	Red Rock	Pea Rock
Percent Absorption	Min.	0.40	0.61	0.31	1.75	no data	1.14
	Max.	0.92	0.72	0.59	5.44	no data	2.32
	Avg.	0.59	0.67	0.43	2.80	-	1.69

(Wood et al. 2006)

Surface Correction Factor, S

- New surfaces will not absorb much binder
- Older surfaces can absorb a lot of binder
- Must be included in design
- Not all roads in a project will need same amount of asphalt binder



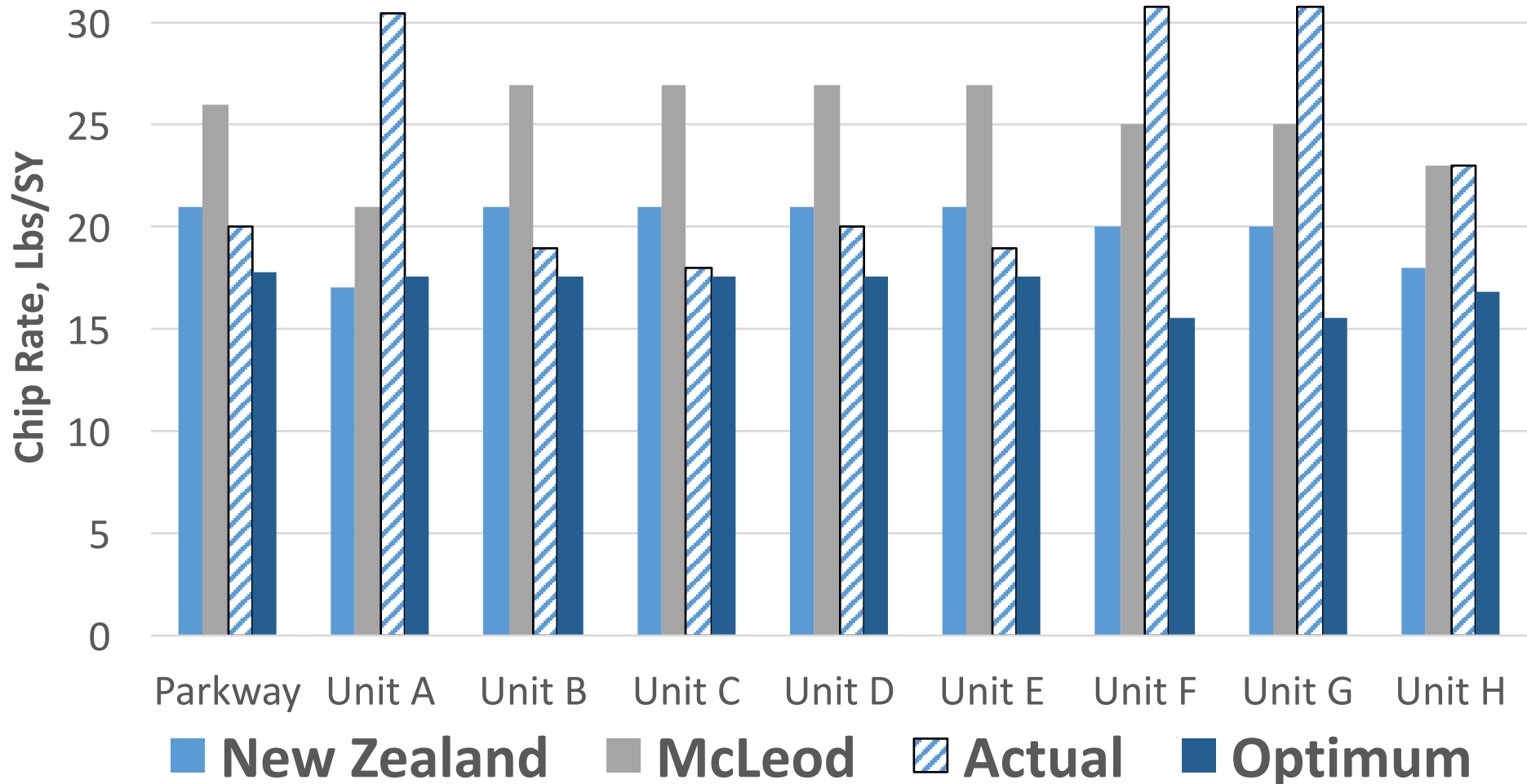
(Wood et al. 2006)

Existing Pavement Texture	Correction, S	
	S.I. Metric (L/m ²)	U. S. Customary (gal/yd ²)
Black, flushed asphalt	-0.04 to -0.27	-0.01 to -0.06
Smooth, non-porous	0.00	0.00
Slightly porous & oxidized	+0.14	+0.03
Slightly pocked, porous & oxidized	+0.27	+0.06
Badly pocked, porous & oxidized	+0.40	+0.09

Comparison of All Chip Application Rates

Test Section	New Zealand Chip Rate Lbs/SY	McLeod Cover Aggregate Rate (lbs/yd ²)	Actual Applied Rate (lbs/yd ²)	Rates given in CY/SY
Parkway	21	26	20	
Unit A	17	21	30.5**	0.013
Unit B	21	27	19	
Unit C	21	27	18	
Unit D	21	27	20	
Unit E	21	27	19	
Unit F	20	25	30.8**	0.013
Unit G	20	25	30.8**	0.013
Unit H	18	23	23	

Chip Seal Design Findings

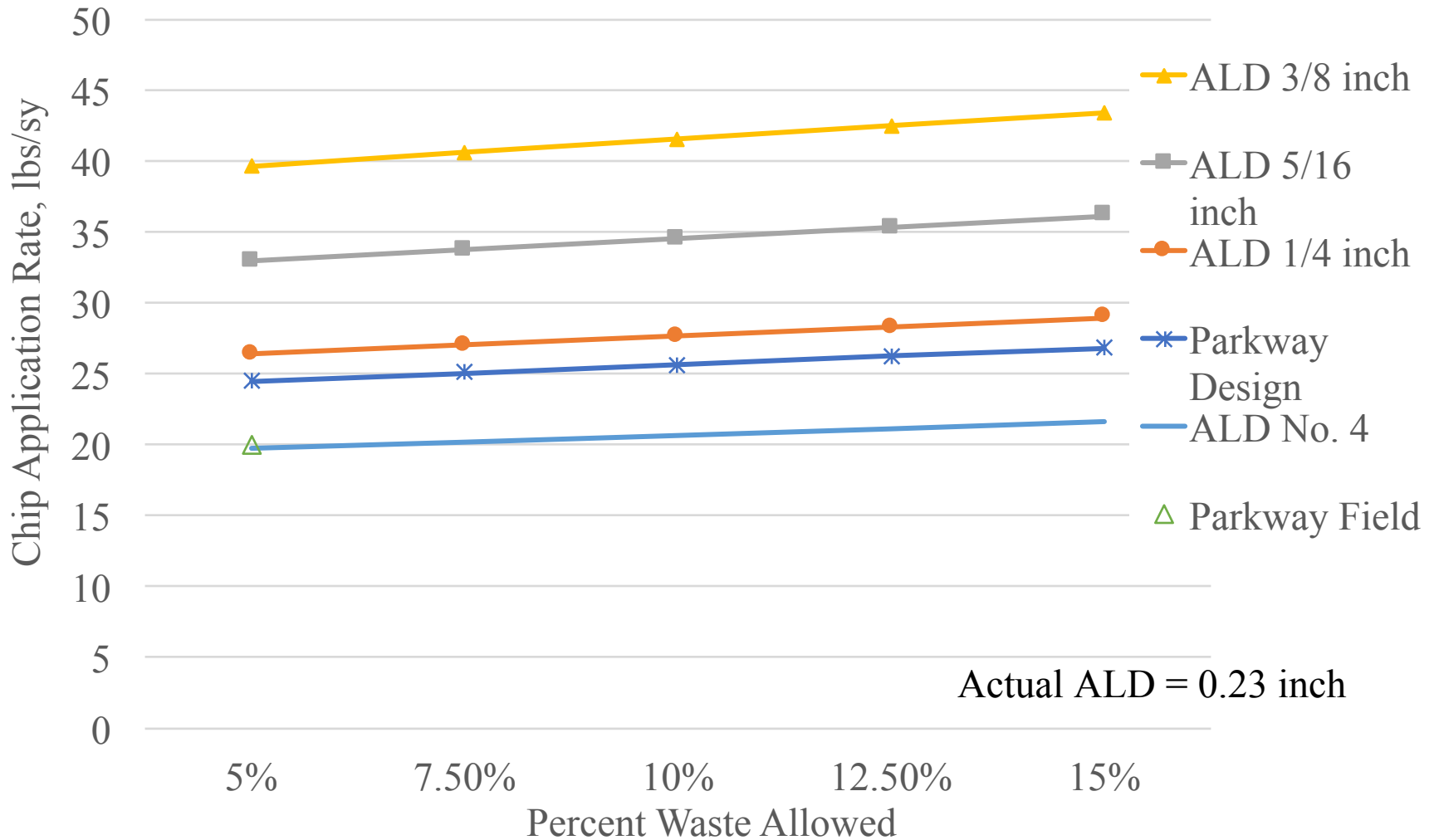


Comparison of All Binder Application Rates

Test Section	Binder Application Starting Rate in Field (gal/sy) (Different surface factors: S=0.06 / S=0.09)	New Zealand Method (gal/sy)	Actual Binder Rate (gal/sy)
Parkway	0.24/0.25	*	0.41 gallons / sy
Unit A	0.43/0.44	0.36	0.48 gallons / sy
Unit B	0.25/0.27	0.37	0.37 gallons / sy
Unit C	0.25/0.27	0.36	0.37 - 0.38 gallons / sy
Unit D	0.26/0.28	0.40	0.37 gallons / sy
Unit E	0.26/0.28	0.39	0.36 gallons / sy
Unit F	0.39/0.42	0.34	0.50 gallons / sy
Unit G	0.44/0.46	0.39	0.50 gallons / sy
Unit H	0.44/0.45	0.41	0.52 gallons / sy

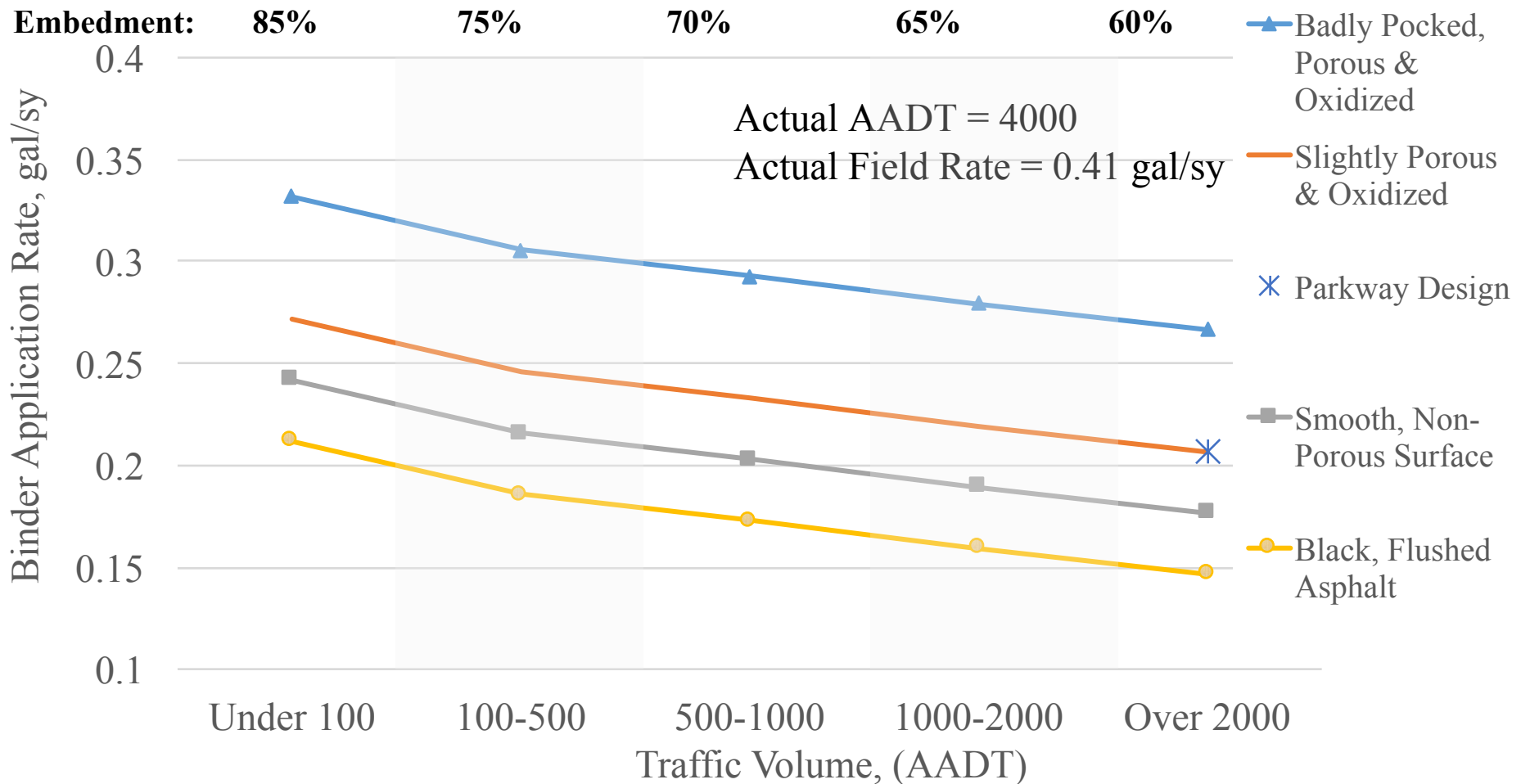
Chip Application Rate on a Hot-Applied Chip Seal

■ ALD and Percent Waste



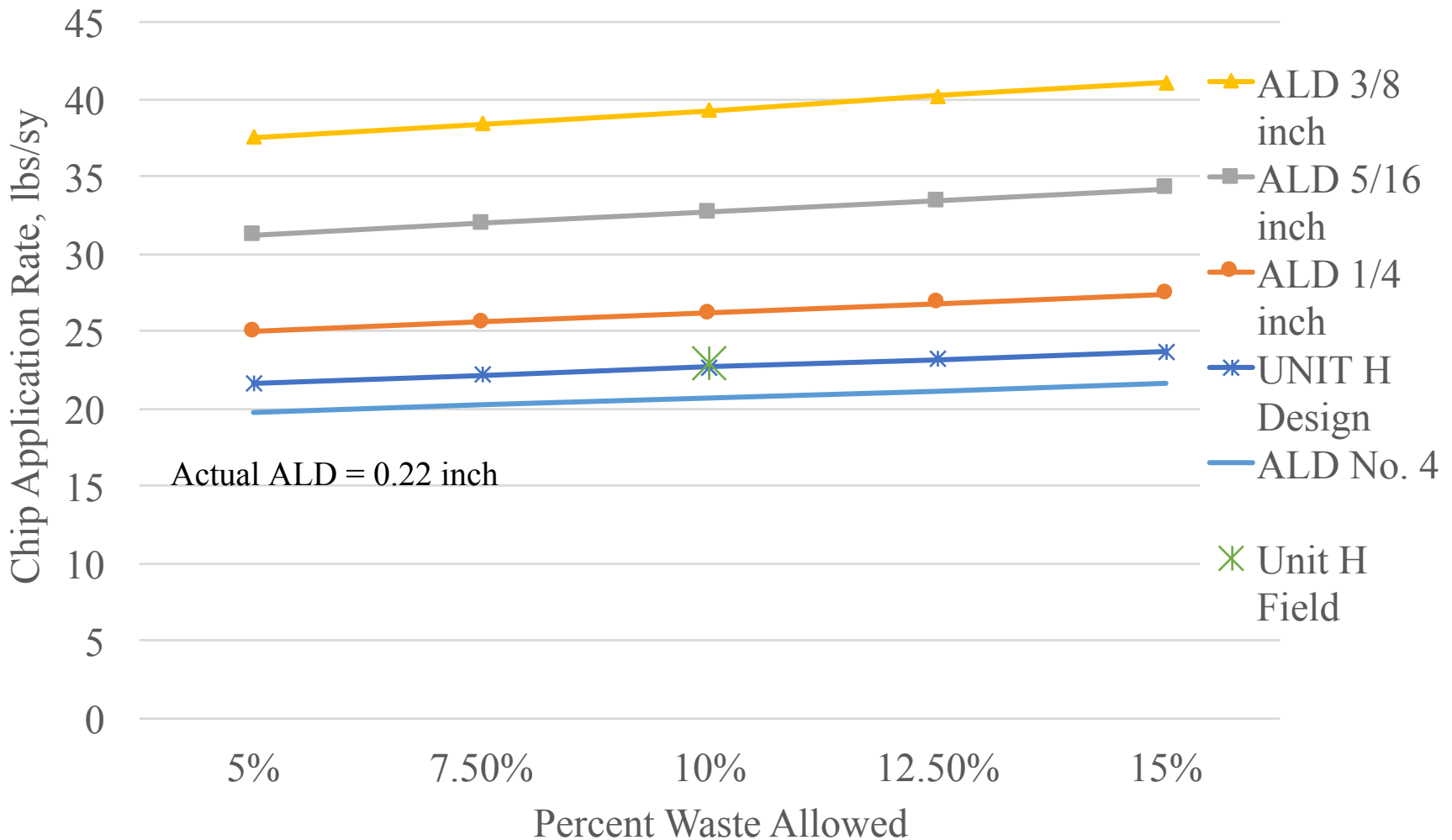
Binder Application Rate on a Hot-Applied Seal

• Traffic and Surface Texture



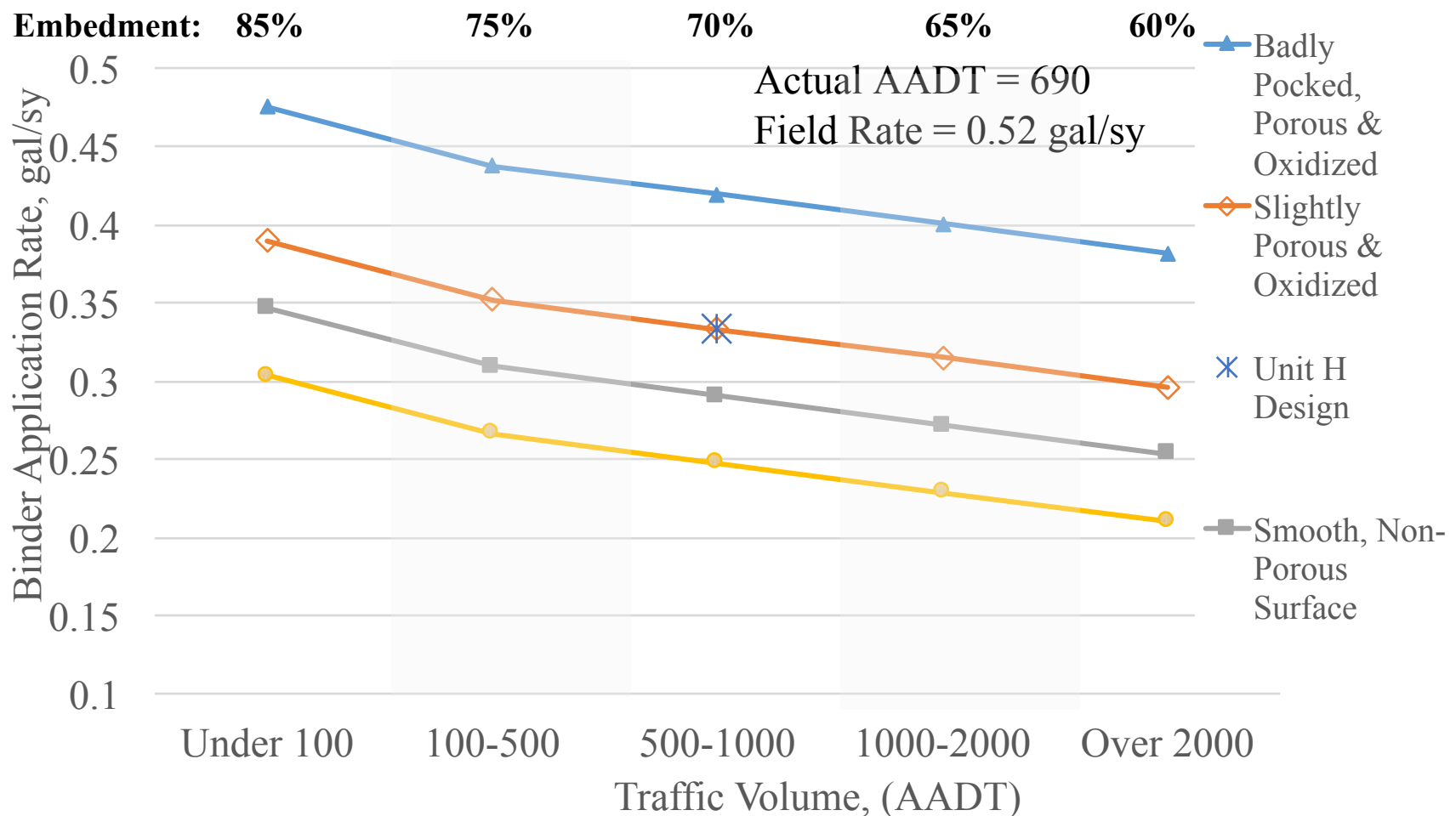
Chip Application Rate on a Emulsified Chip Seal

■ ALD and Percent Waste



Binder Application Rate for an Emulsified Chip Seal

- Traffic and Surface Texture



Preliminary Findings

- **All three chip seals with chip-seal related distresses are hot-apply**
- **Both chip seal types show an overall improvement in pavement condition**
- **Dynamic Friction Data was consistent between sections- inconsistent between years.**
- **All chip seals passed the New Zealand one-year performance specification**
- **Emulsified chip seals tended to be over-chipped whereas Hot-apply were close to the design**

Recommendations

- **Know the materials**
- **Pre-seal pavement condition plays a key role**
- **Projects demonstrate performance specification proof of concept**
- **Design methods provide engineering approach and a framework for chip seal education**

Next Steps

- **Finalize Design Guide**
- **Phase II Implementation Phase**
 - **Chip Seal Workshops**
 - **Teach Chip Seal Design Methodology**
 - **Design Lab-Field Validation**
 - **Introduce New Zealand Performance Specification**

Thank you!

